



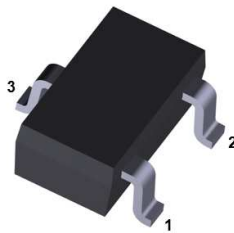
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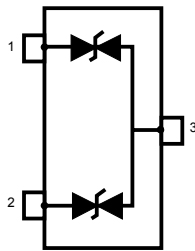
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Automotive dual-line TVS in SOT23-3L for CAN bus




SOT23-3L
(Jedec TO-236)



Product status link

ESDCANxx-2BLY	ESDCAN01-2BLY , ESDCAN24-2BLY , ESDCAN04-2BLY , ESDCAN06-2BLY
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Features

- AEC-Q101 qualified 
- Dual-line ESD and EOS protection
- Breakdown voltage: V_{BR}
 - ESDCAN01-2BLY: 25 V
 - ESDCAN24-2BLY: 27 V
 - ESDCAN04-2BLY: 27.5 V
 - ESDCAN06-2BLY: 38 V
- Bidirectional device
- Max pulse power up to 230 W (8/20 μ s)
- Low clamping factor V_{CL} / V_{BR}
- Low leakage current
- **ECOPACK** ROHS compliant component

Complies with the following standards

- UL94, V0
- J-STD-020 MSL level 1
- IPC7531 footprint and JEDEC registered package
- ISO 16750-2 (Jump start and reversed battery tests)
- ISO 10605 - C = 150 pF, R = 330 Ω , exceeds level 4:
 - ± 30 kV (air discharge)
 - ± 30 kV (contact discharge)
- ISO 10605 - C = 330 pF, R = 330 Ω exceeds level 4:
 - ± 30 kV (air discharge)
 - ± 30 kV (contact discharge)
- ISO 7637-3:
 - Pulse 3a: -150 V
 - Pulse 3b: +150 V
 - Pulse 2a: +/- 85 V

Applications

Automotive controller area network (CAN) bus lines where electrostatic discharges and other transients must be suppressed. This product is compliant with most of automotive interfaces.

Description

The ESDCAN0xx-2BLY are dual-line TVS specifically designed for the protection of automotive CAN bus lines against electrostatic discharge (ESD).

Its improved parameters make it compliant with all key interfaces in automotive: CAN-FD, LIN, FlexRay, MOST, SENT, USB, etc.

1 Characteristics

Table 1. Absolute ratings ($T_{amb} = 25\text{ °C}$)

Symbol	Parameter		Value	Unit	
V_{PP}	Peak pulse voltage	ISO 10605 - C = 150 pF, R = 330 Ω :			
		Contact discharge	30	kV	
		Air discharge	30		
		ISO 10605 - C = 330 pF, R = 330 Ω :	ESDCAN24-2BLY		
		Contact discharge	ESDCAN01-2BLY		30
		Air discharge	ESDCAN04-2BLY		30
ISO 10605 - C = 330 pF, R = 330 Ω :	ESDCAN06-2BLY				
Contact discharge	ESDCAN06-2BLY	22			
Air discharge	ESDCAN06-2BLY	22			
I_{PP}	Peak pulse current (8/20 μ s)	ESDCAN24-2BLY	5.5	A	
		ESDCAN01-2BLY			
		ESDCAN04-2BLY	3.7		
		ESDCAN06-2BLY	3		
T_j	Operating junction temperature range		-40 to +150	$^{\circ}\text{C}$	
T_{stg}	Storage temperature range		-55 to +150	$^{\circ}\text{C}$	

Figure 1. Electrical characteristics (definitions)

Symbol	Parameter
V_{BR}	= Breakdown voltage
V_{RM}	= stand-off voltage
V_{CL}	= Clamping voltage
I_{RM}	= Leakage current at V_{RM}
I_{PP}	= Peak pulse current
R_d	= Dynamic impedance
C_{LINE}	= Input capacitance per line

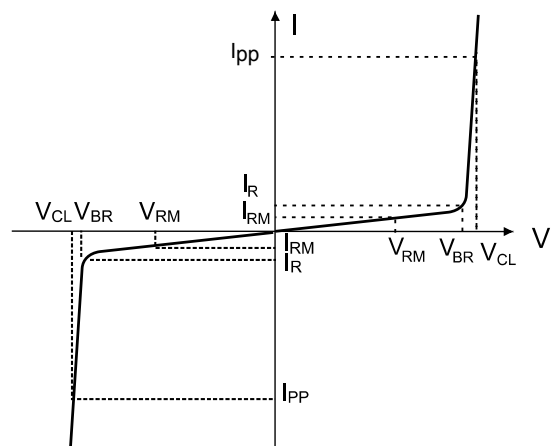


Table 2. Electrical characteristics (values, $T_{amb} = 25\text{ °C}$)

Order code	I_{RM} max. at V_{RM}		V_{BR} at I_R			V_{CL} Pulse ISO7637-3		V_{CL} at I_{PP} (8/20 μ s)		C		$\Delta C^{(1)}$	$\alpha T^{(2)}$
			Min.	Max.		3a at -150 V min.	3b at +150 V max.	Max.		Typ.	Max.	Typ.	Typ.
	μ A	V	V		mA	V		V	A	pF		pF	$10^{-4}/\text{°C}$
ESDCAN24-2BLY	0.1	24	27	32	1	-40	40	43	5	-	30	0.1	9
ESDCAN01-2BLY	0.1	24	25	30	1	-35	35	40	5	-	30	0.1	9
ESDCAN04-2BLY	0.05	25.5	27.5	30.7	1	-35	35	43	3	17	19	0.1	9
ESDCAN06-2BLY	0.1	35	38	42.2	1	-44	44	59	3	13	15	0.1	9

1. ΔC : capacitance variation between IO1 and IO2 versus GND

2. to calculate V_{BR} versus T_j ; V_{BR} at $T_j = V_{BR}$ at $25\text{ °C} \times (1 + \alpha T \times (T_j - 25))$

1.1 Characteristics (curves)

Figure 2. Maximum peak current versus initial junction temperature

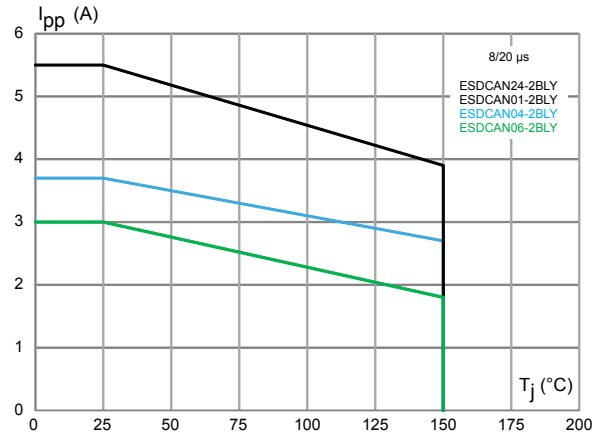


Figure 3. Maximum peak pulse current versus exponential pulse duration

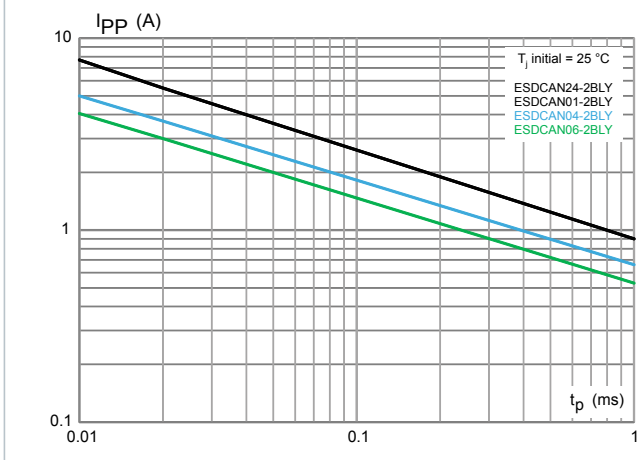


Figure 4. Clamping voltage versus peak pulse current

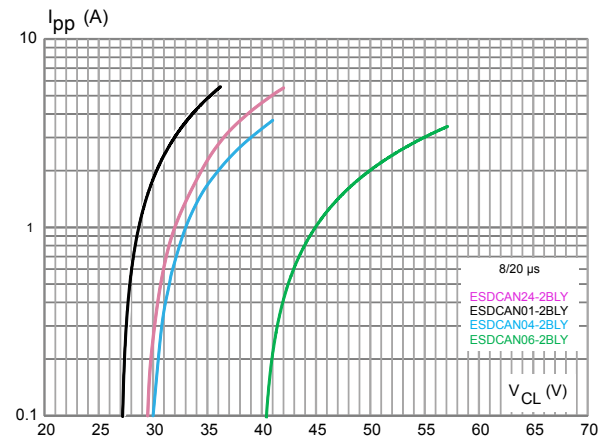


Figure 5. Junction capacitance versus reverse voltage

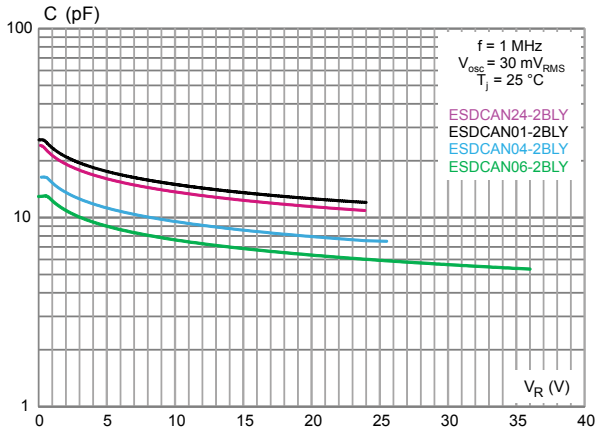


Figure 6. Leakage current versus junction temperature

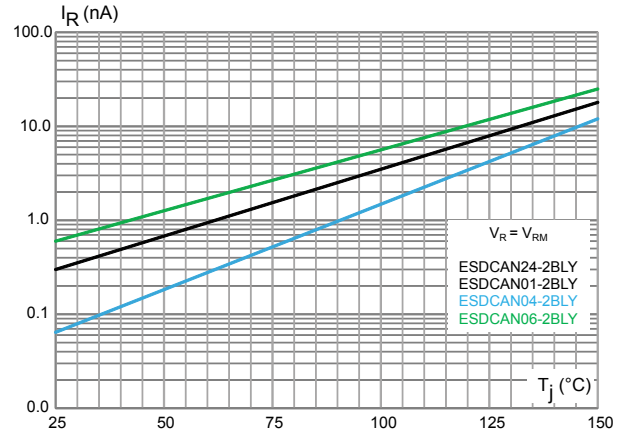


Figure 7. Response to ISO 10605 -C = 150 pF, R = 330 Ω (-8 kV contact)

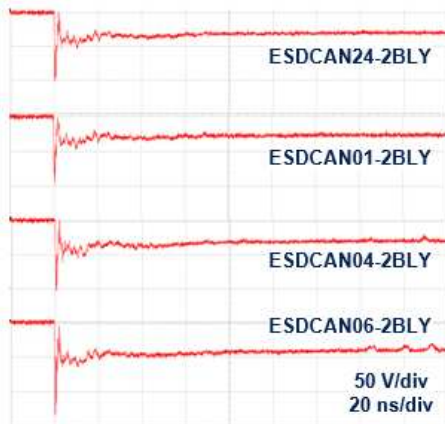


Figure 8. Response to ISO 10605 - C = 150 pF, R = 330 Ω (+8 kV contact)

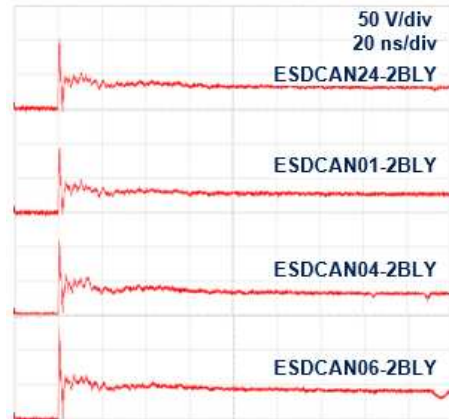


Figure 9. Response to ISO 7637-3 Pulse 3a: -150 V

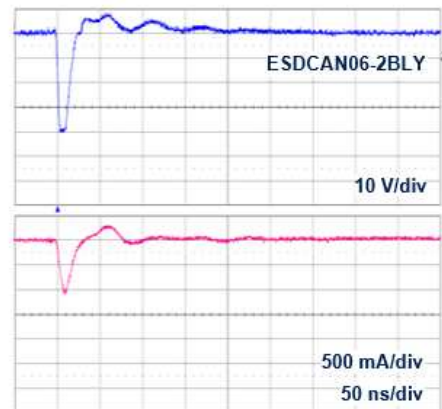
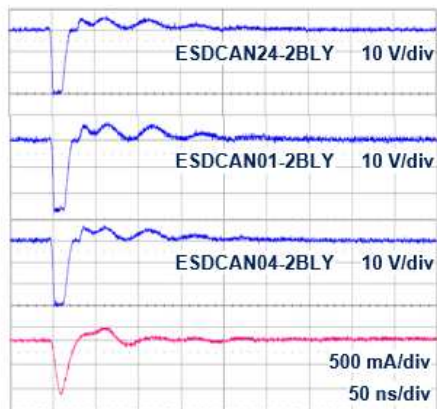


Figure 10. Response to ISO 7637-3 Pulse 3b : +150 V

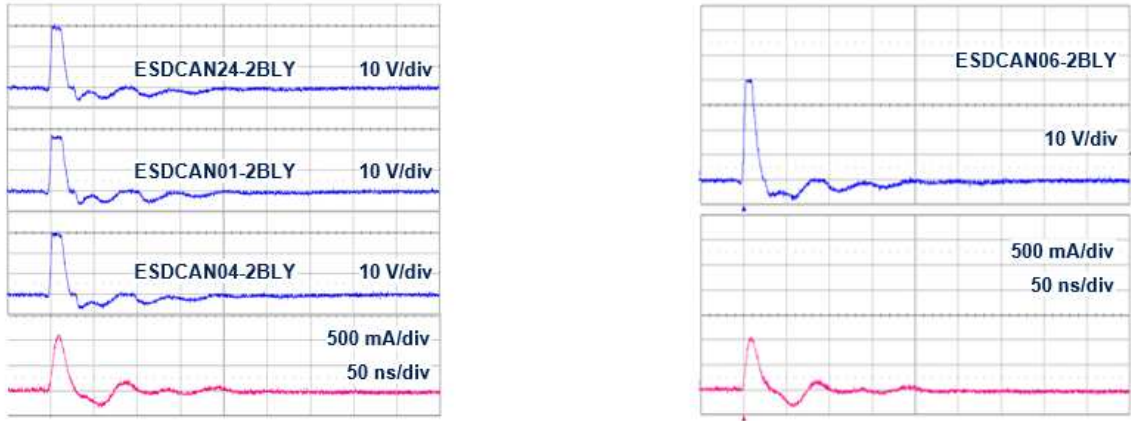


Figure 11. Response to ISO 7637-3 pulse 2a: -85 V

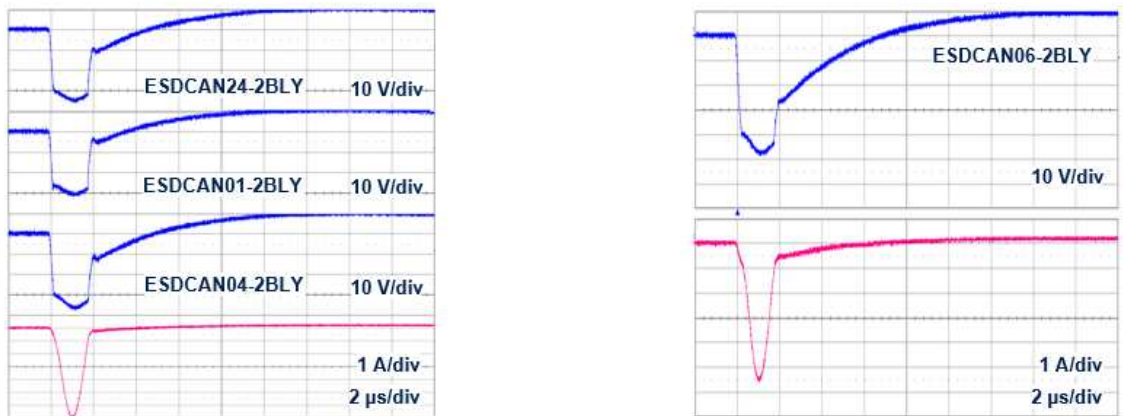


Figure 12. Response to ISO 7637-3 pulse 2a: +85 V

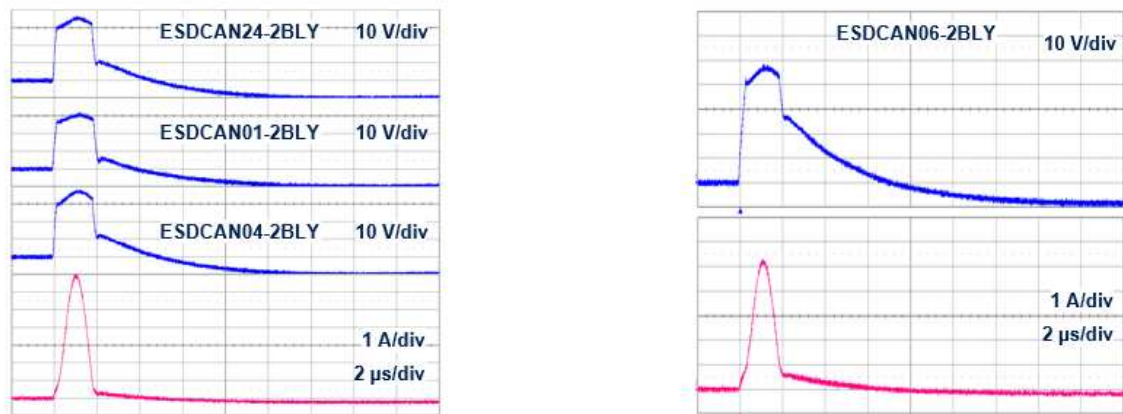


Figure 13. S21 attenuation

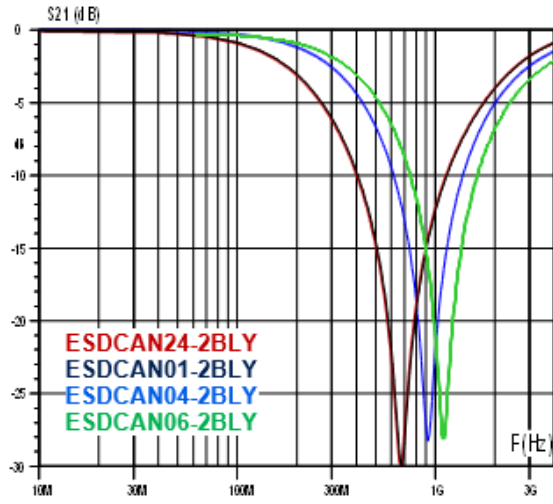
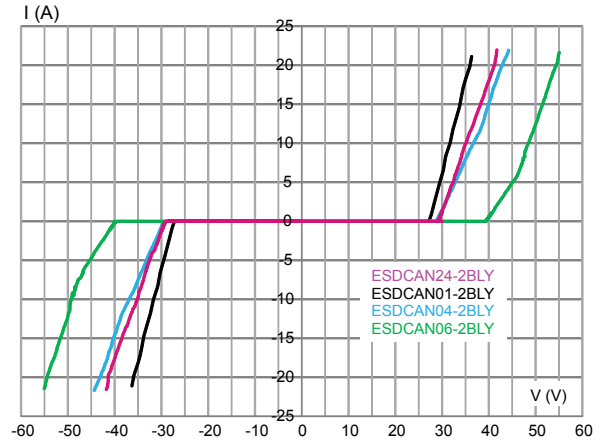


Figure 14. TLP



2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of **ECOPACK** packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 SOT23-3L package information

Figure 15. SOT23-3L package outline

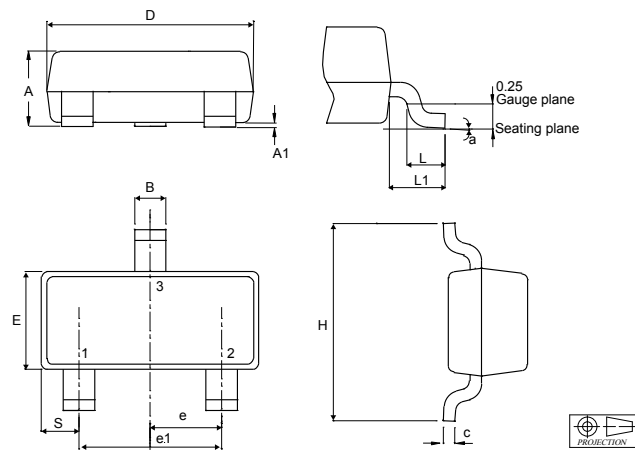


Table 3. SOT23-3L package mechanical data

Ref.	Dimensions					
	Millimeters			Inches ⁽¹⁾		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.89		1.25	0.0350		0.050
A1	0.00		0.15	0.0000		0.006
B	0.30		0.51	0.011		0.021
C	0.085		0.20	0.003		0.008
D	2.75		3.04	0.108		0.120
E	1.20		1.75	0.047		0.069
e	0.85	0.95	1.05	0.033	0.037	0.042
e1	1.70	1.90	2.10	0.066	0.075	0.083
H	2.10		3.00	0.082		0.119
L	0.25		0.61	0.009		0.025
L1		0.55			0.022	
S	0.35		0.65	0.013		0.026
a	0°		8°	0°		8°

1. Dimension in inches are given for reference only.

Figure 16. SOT23-3L marking

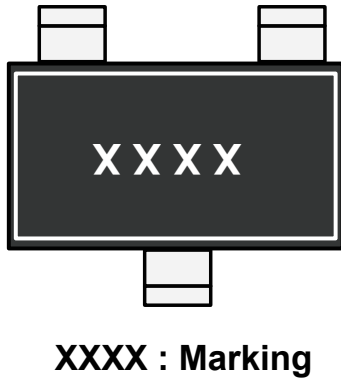


Figure 17. SOT23-3L footprint in mm

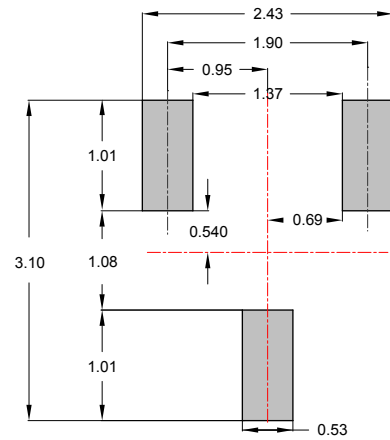
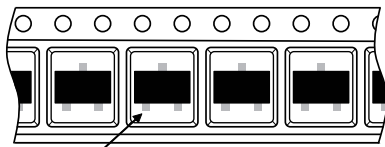


Figure 18. Package orientation in reel



Pin 1 located according to EIA-481

Note: Pocket dimensions are not on scale
Pocket shape may vary depending on package

Figure 19. Tape and reel orientation

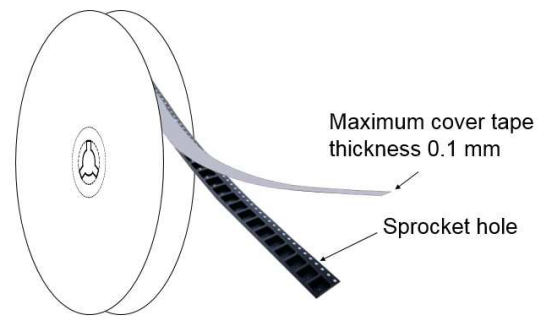


Figure 20. 7" reel dimension values

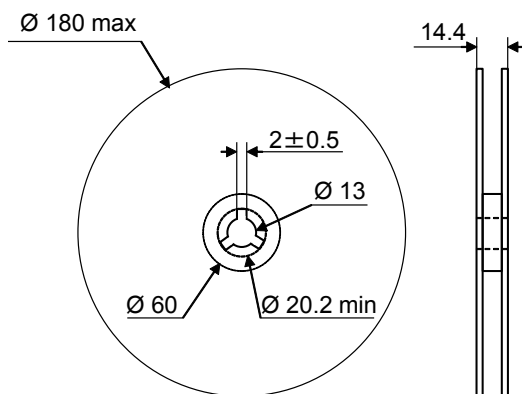


Figure 21. Inner box dimension values

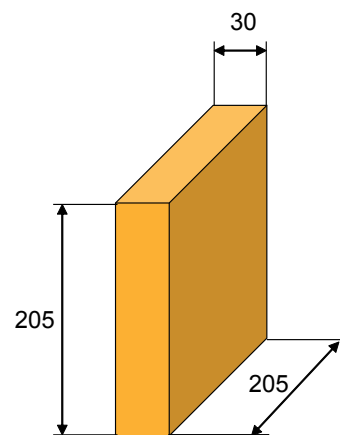
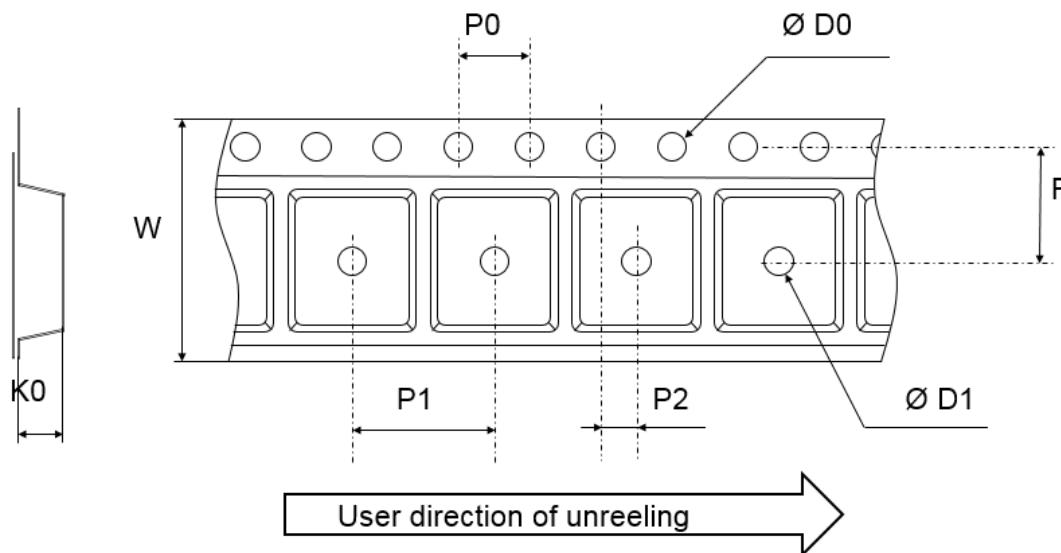


Figure 22. Tape outline



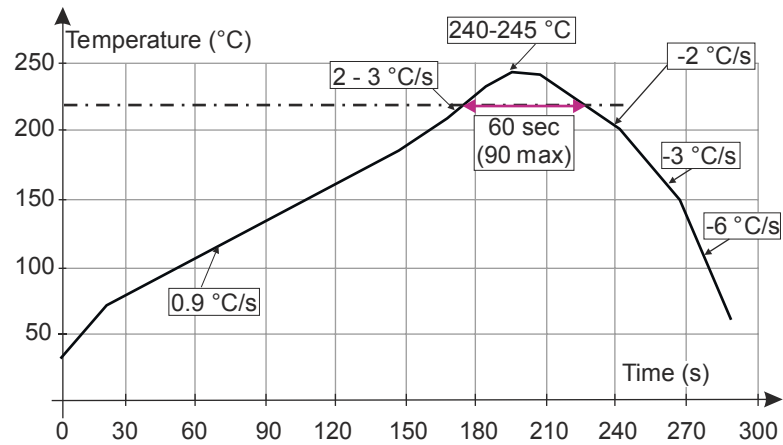
Note: Pocket dimensions are not on scale
Pocket shape may vary depending on package

Table 4. Tape dimension values

Ref.	Dimensions		
	Millimeters		
	Min.	Typ.	Max.
D0	1.45	1.5	1.6
D1	1		
F	3.45	3.5	3.55
K0	1.3	1.4	1.5
P0	3.9	4.0	4.1
P1	3.9	4.0	4.1
P2	1.95	2.0	2.05
W	7.9	8	8.3

3 Reflow profile

Figure 23. ST ECOPACK® recommended soldering reflow profile for PCB mounting



Note: Minimize air convection currents in the reflow oven to avoid component movement. Maximum soldering profile corresponds to the latest IPC/JEDEC J-STD-020.

4 Ordering information

Figure 24. Ordering information scheme

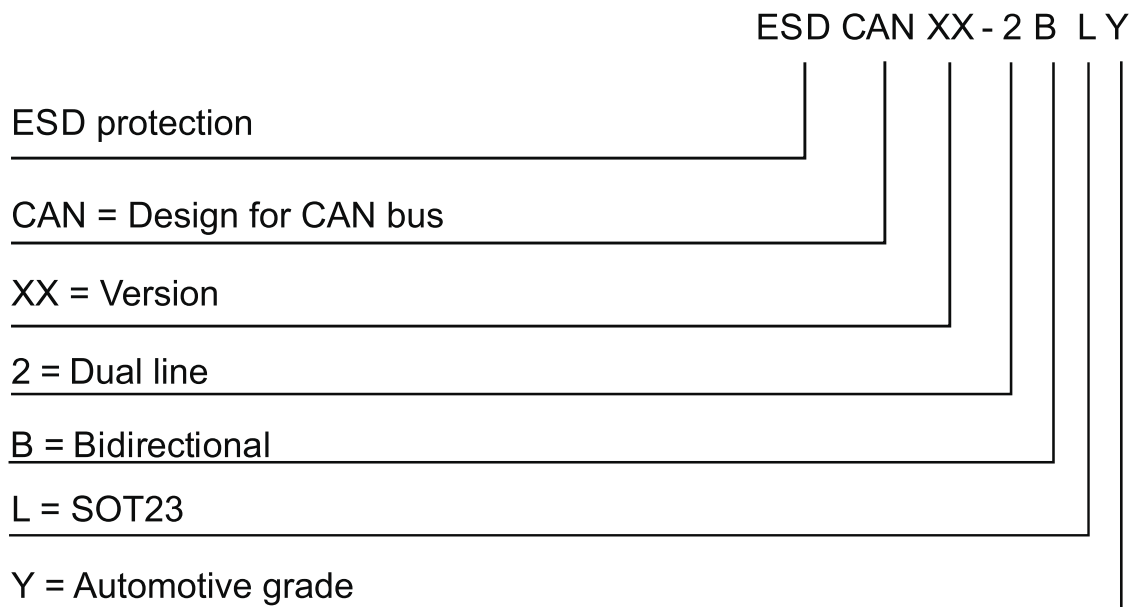


Table 5. Ordering information

Order code	Marking ⁽¹⁾	Package	Weight	Base qty.	Delivery mode
ESDCAN24-2BLY	EL24	SOT23-3L	9.8 mg	3000	Tape and reel
ESDCAN01-2BLY	EN24				
ESDCAN04-2BLY	EC24				
ESDCAN06-2BLY	EC35				

1. The marking can be rotated by multiples of 90° to differentiate assembly location

Revision history

Table 6. Document revision history

Date	Revision	Changes
13-Jul-2015	1	First issue.
04-Oct-2018	2	Added RPN ESDCAN04-2BLY and ESDCAN06-2BLY. Updated cover page, Section 1 Characteristics and Section 1.1 Characteristics (curves) . Added Packing information.
05-Apr-2019	3	Added typical pitch in Table 3 and updated Figure 17 .

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